

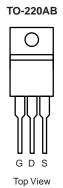
K3480-VB Datasheet N-Channel 100-V (D-S) MOSFET

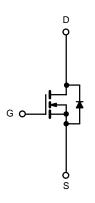
PRODUCT SUMMARY					
V _{DS} (V)	100				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0. 036				
I _D (A) ^a	55				
Configuration	Single				

FEATURES

- Trench Power MOSFETS
- 175 °C Junction Temperature
- Low Thermal Resistance Package







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless oth	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C		55	
	T _C = 125 °C	l _D	40	
Pulsed Drain Current	I _{DM}	135	A	
Avalanche Current	I _{AR}	35		
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	61	mJ
W	T _C = 25 °C	В	127 ^b	10/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_{D}$ $-$	3.75	W
Operating Junction and Storage Temperature Range		T _I , T _{sta}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	(PCB Mount) ^c	R _{thJA}	40	°C/W		
unction-to-Case (Drain)		R _{thJC}	1.4	C/VV		

Notes:

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Cymbol	rest conditions		196.	Mux.	O i iii	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{SS} = 0 V, I _D = 250 μA	100	1			
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
	000	V _{DS} = 100 W _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C			50 µA		
, and the second		V _{DS} = 80 V, V _{GS} = 0 V, T _J = 175 °C			250	-	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	75			Α	
	= (5)	V _{GS} = 10 V, I _D = 5 A		0.036		Ω	
_		V _{GS} = 4.5 V, I _D = 3 A		0.038			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C		0.050			
		V _{GS} = 10 V, I _D = 3 A, T _J = 175 °C		0.065		-	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	10			S	
Dynamic ^b							
Input Capacitance	C _{iss}			4500		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		270			
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge ^c	Qg			35	60		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 40 \text{ A}$		11		nC	
Gate-Drain Charge ^c	Q_{gd}			9			
Gate Resistance	R_{G}			1.7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			11	20		
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, R_{L} = 1.25 \Omega$		12	20		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 40 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		30	45	ns	
Fall Time ^c	t _f			12	20	1	
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b		•			
Continuous Current	I _S				40	А	
Pulsed Current	I _{SM}				120		
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			60	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	$I_F = 30 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		5	8	Α	
Reverse Recovery Charge	Q _{rr}			0.15	0.4	μC	

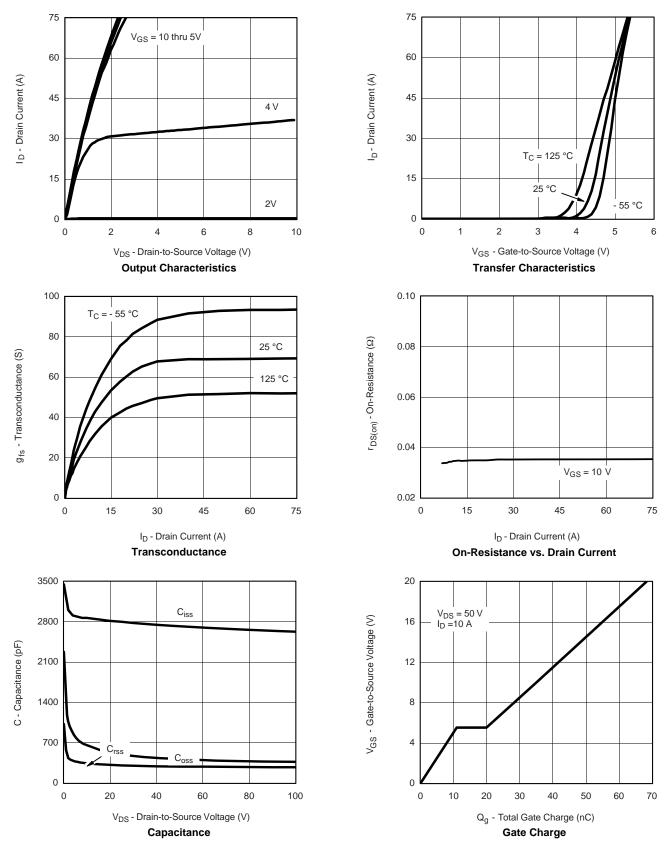
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

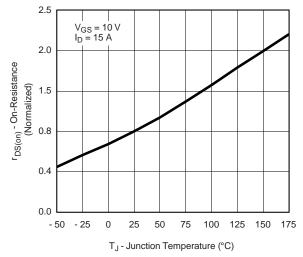


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

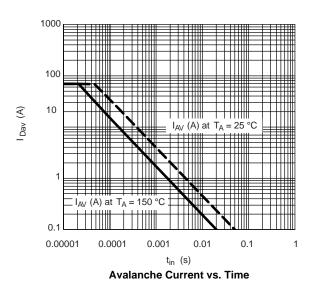




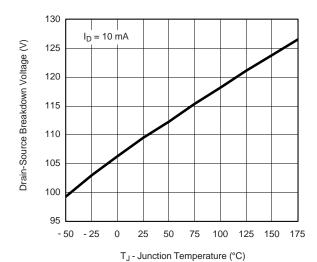
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Junction Temperature



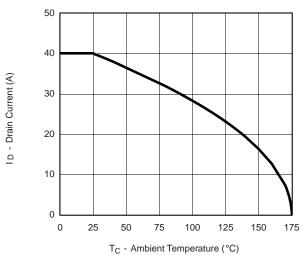
Source-Drain Diode Forward Voltage



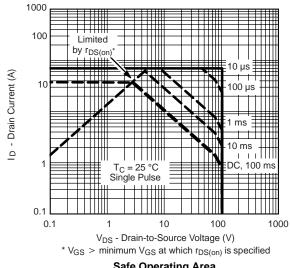
Drain-Source Breakdown Voltage vs. Junction Temperature



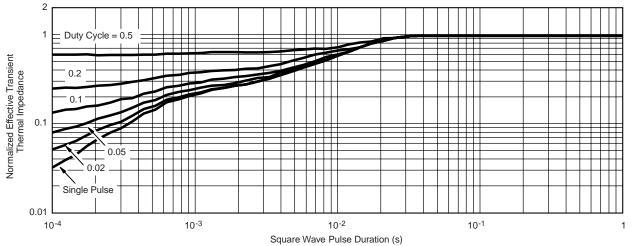
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



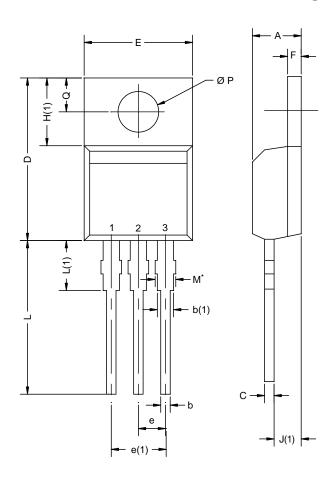
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

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TO-220AB



	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471					

Notes

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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